

MiniSKiiP[®] 1

Sixpack

SKiiP 14AC12T7V1

Features*

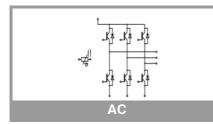
- 1200V Generation 7 IGBTs (T7)
- Robust and soft switching freewheeling diodes in CAL technology
- Highly reliable spring contacts for electrical connections
- UL recognized: File no. E63532

Remarks

- Max. case temperature limited to $T_{C}\text{=}T_{S}\text{=}125\ ^{\circ}\text{C}$
- Product reliability results valid for Tj≤150 °C (recommended Tion=-40...+150 °C)
- T_{j,op}=-40...+150 °C)
 MiniSKiiP "Technical Explanations" and "Mounting Instructions" are part of the data sheet. Please refer to both documents for further information.
- For storage and case temperature with TIM see document: "Technical Explanations Thermal Interface Materials"

	Maximum Ratings	1		Unit	
Symbol	Conditions		Values		
Inverter -	IGBT				
V _{CES}	T _j = 25 °C		1200	V	
lc	λ _{paste} =0.8 W/(mK)	T _s = 70 °C	47	Α	
	T _j = 175 °C	T _s = 100 °C	39	A	
I _C	λ _{paste} =2.5 W/(mK)	T _s = 70 °C	53	Α	
	T _j = 175 °C	T _s = 100 °C	43	Α	
I _{Cnom}			35	А	
I _{CRM}			70	A	
V _{GES}			-20 20	V	
t _{psc}	$V_{CC} = 800 V$ $V_{GE} \le 15 V$ $V_{CES} \le 1200 V$	T _j = 175 °C	7	μs	
Tj			-40 175	°C	
Inverse -	Diode				
l _F	λ _{paste} =0.8 W/(mK)	T _s = 70 °C	37	А	
	T _j = 175 °C	T _s = 100 °C	30	Α	
I _F	λ _{paste} =2.5 W/(mK)	T _s = 70 °C	41	Α	
	T _j = 175 °C	T _s = 100 °C	34	Α	
I _{FRM}			70	Α	
I _{FSM}	t _p = 10 ms, sin 180°	°, T _j = 150 °C	170	Α	
Tj			-40 175	°C	
Module				I	
I _{t(RMS)}	T _{terminal} = 80 °C, 20 A per spring		40	A	
T _{stg}	module without TIM		-40 125		
Visol	AC sinus 50 Hz, t = 1 min		2500	V	

Characteristics								
Symbol	Conditions		min.	typ.	max.	Unit		
Inverter - IGBT								
V _{CE(sat)}	I _C = 35 A V _{GE} = 15 V	T _j = 25 °C		1.60	1.75	V		
		T _j = 150 °C		1.82	1.96	V		
	chiplevel	T _j = 175 °C		1.86	2.00	V		
V _{CE0}		T _j = 25 °C		0.90	1.00	V		
	chiplevel	T _j = 150 °C		0.75	0.83	V		
		T _j = 175 °C		0.72	0.80	V		
r _{CE}	151	T _j = 25 °C		20	21	mΩ		
	V _{GE} = 15 V chiplevel	T _j = 150 °C		31	32	mΩ		
		T _j = 175 °C		33	34	mΩ		
V _{GE(th)}	$V_{GE} = V_{CE}, I_{C} = 0.7$	5 mA	5.15	5.8	6.45	V		
I _{CES}	$V_{GE} = 0 V, V_{CE} = 12$	200 V, T _j = 25 °C			1	mA		
Cies		f = 1 MHz		6.60		nF		
C _{oes}	V _{CE} = 25 V V _{GE} = 0 V	f = 1 MHz		0.09		nF		
C _{res}		f = 1 MHz		0.02		nF		
Q _G	V _{GE} = - 8V + 15 V			490		nC		
R _{Gint}	T _j = 25 °C		0		Ω			





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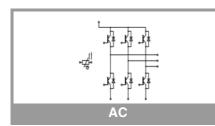
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Characteristics						
Symbol	Conditions		min.	typ.	max.	Unit
Inverter -	IGBT					•
t _{d(on)}		T _j = 25 °C		37		ns
		T _j = 150 °C		39		ns
		T _j = 175 °C		40		ns
t _r		T _j = 25 °C		37		
	V _{CC} = 600 V	T _j = 150 °C		43		
	$I_{\rm C} = 35 \rm{A}$	T _j = 175 °C		46		
Eon	$R_{G on} = 9.1 \Omega$ $R_{G off} = 9.1 \Omega$ $V_{GE} = +15/-15 V$	T _j = 25 °C		3.1		
		T _j = 150 °C		4.4		
		T _j = 175 °C		4.6		
t _{d(off)}		T _j = 25 °C		231		
		T _j = 150 °C		321		ns
		T _j = 175 °C		346		
t _f		T _j = 25 °C		48		ns
		T _j = 150 °C		74		ns
		T _j = 175 °C		90		ns
E _{off}		T _j = 25 °C		2.3		mJ
	1	T _j = 150 °C		3.9		mJ
		T _j = 175 °C		4.2		
R _{th(j-s)}	per IGBT, λ _{paste} =0.		0.92			
R _{th(j-s)}	per IGBT, λ _{paste} =2.	5 W/(mK)		0.76		K/W

Characteristics Symbol Conditions min. max. Unit typ. Inverse - Diode $V_F = V_{EC}$ T_i = 25 °C 2.30 2.62 ۷ $I_{F} = 35 A$ $V_{GE} = 0 V$ T_i = 150 °C 2.29 2.62 V chiplevel T_i = 175 °C 2.14 2.46 v V_{F0} T_i = 25 °C 1.30 1.50 V T_i = 150 °C chiplevel 0.90 1.10 V T_i = 175 °C V 0.82 0.98 T_i = 25 °C 29 32 mΩ r_F chiplevel T_i = 150 °C 40 43 mΩ T_i = 175 °C 38 42 mΩ T_i = 25 °C I_{RRM} 22 А T_i = 150 °C 28 А $I_{F} = 35 \text{ A}$ T_i = 175 °C 33 А V_{GE} = +15/-15 V Qrr T_i = 25 °C 2 μC $V_{CC} = 600 V$ T_i = 150 °C 5.2 μC T_i = 175 °C 5.7 μC @ T_i = 150 °C: E_{rr} T_i = 25 °C 0.61 $di/dt_{off} = 870 \text{ A}/\mu s$ mJ T_j = 150 °C 2 mJ T_i = 175 °C 2.6 mJ per Diode, $\lambda_{paste}=0.8 \text{ W/(mK)}$ R_{th(j-s)} 1.1 K/W per Diode, $\lambda_{paste} = 2.5 \text{ W/(mK)}$ 0.93 K/W R_{th(j-s)} Module nΗ LCF -2.5 M_s to heat sink Nm 2 w 30 g



Characteristics

Characteristics							
Symbol	Conditions	min.	typ.	max.	Unit		
Temperature Sensor							
R ₁₀₀	T _r =100°C (R ₂₅ =1000Ω)		1670 ± 3%		Ω		
R _(T)	$\begin{split} & R_{(T)}{=}1000\Omega[1{+}A(T{-}25^\circ\text{C}){+}B(T{-}25^\circ\text{C})^2] \\ , A = 7.635^*10^{-3\circ}\text{C}^{-1}, \\ & B = 1.731^*10^{-5\circ}\text{C}^{-2} \end{split}$						

Creepage distance (spring to spring) between temperature sensor and phase W = 2.9mm (CTI 600)

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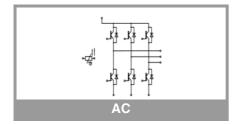
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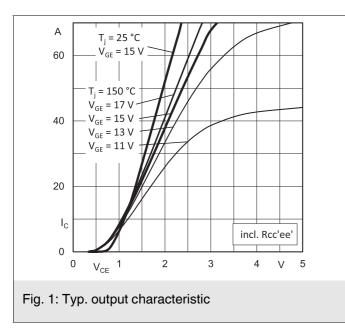
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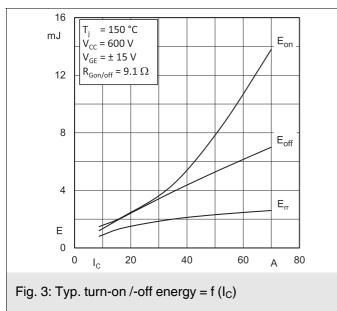
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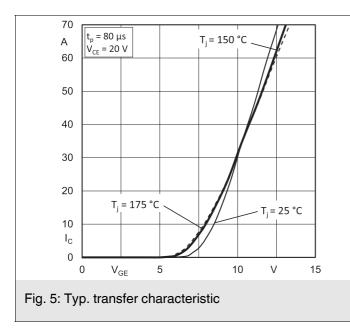
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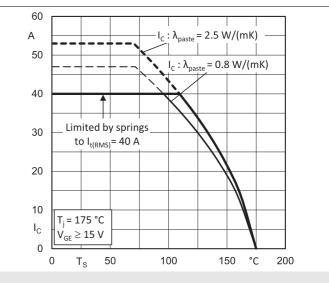
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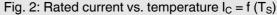


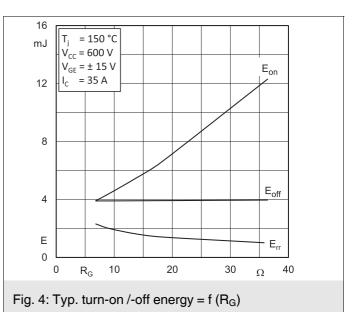












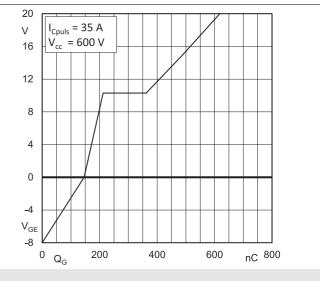
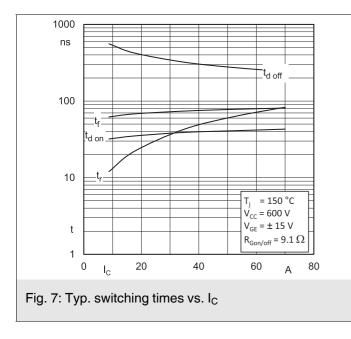
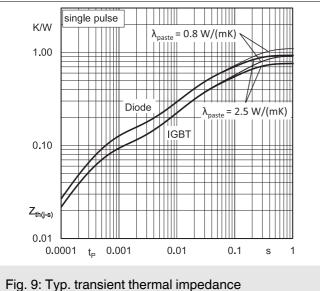
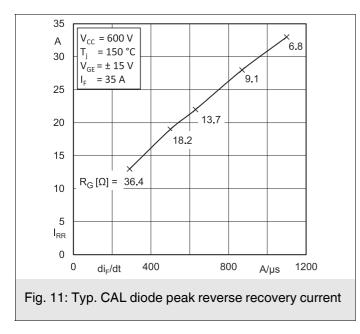
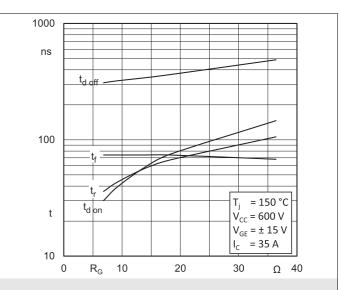


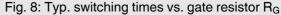
Fig. 6: Typ. gate charge characteristic

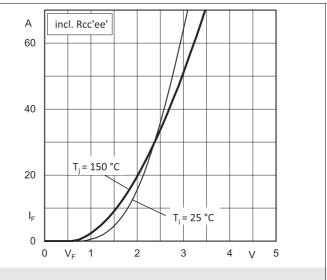


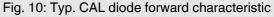


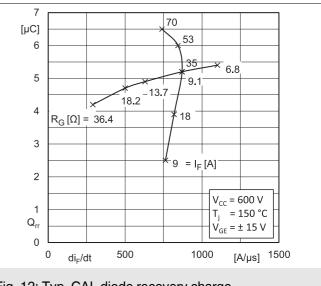


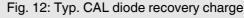




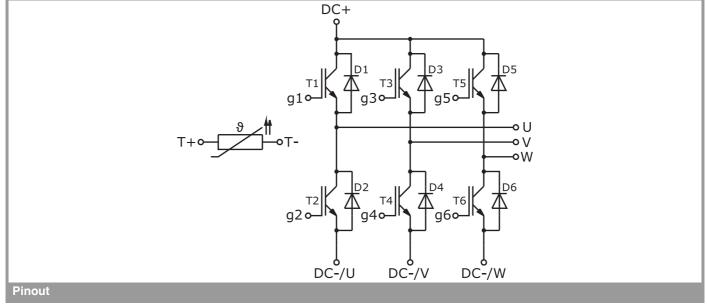








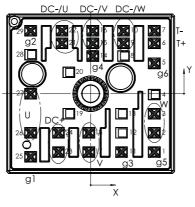
Rev. 1.0 – 24.11.2020



Pinout and Dimensions

Pin out							
Pin	Х	Y	Function	Pin	Х	Y	Function
1	15,93	-14,6	g5	16	0,53	15,8	DC-/V
2	15,93	-9,8	W	17	-0,48	-14,6	V
3	15,93	-5	W	18	-0,48	-9,8	V
4				19			
5	15,93	7,63	g6	20			
6	15,93	12,63	T+	21	-7,18	12,63	DC-/U
7	15,93	15,8	Т-	22	-7,18	15,8	DC-/U
8				23	-8,08	-14,6	DC+
9	8,23	12,63	DC-/W	24	-8,08	-9,8	DC+
10	8,23	15,8	DC-/W	25	-15,03	-15,8	g1
11	7,73	-14,6	g3	26	-15,03	-9,8	U
12				27	-15,03	0	U
13				28			
14	0,53	9,45	g4	29	-15,03	15,8	g2
15	0,53	12,63	DC-/V				

all values in mm



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This is an electrostatic discharge sensitive device (ESDS) due to international standard IEC 61340.

***IMPORTANT INFORMATION AND WARNINGS**

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